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YDS-CMFL143004-IMX317 V1.0 8.51MP Sony IMX317 Fixed Focus Camera Module







Back View

Overview

The Sony IMX317 color image sensor used in the YDS-CML143004-IMX317 V1.0 wide-angle small lens module is a high-performance CMOS 1/2.5" image sensor that can provide 8-megapixel (3840x2160) image signals at up to 60FPS. The pixel size is 1.62um x 1.62um.

When connected to the master board using a coaxial cable, it can support shooting 8MP high-definition images and up to 4K@60FPS (differential) and 4K@30FPS video recording. The board frame size is 14.5x18.1mm, and the size from the top of the module lens to the PCB board is 19.5mm.



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Top View



Side View



Bottom View



Isometric View



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Top View Side View



Bottom View



Isometric View



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Specifications

Model No.	YDS-CMFL143004-IMX317 V1.0		
Image Sensor	IMX317		
Image Sensor Type	CMOS		
Effective Pixels	8.51 Megapixels		
Sensor Size	1/2.5"		
Pixel Size	1.62 um x 1.62 um		
Video Frame Rate	4K@24/25/30/FPS, 4K@48/50/60FPS (Differential) 2.7K@24/25/30/48/50/60FPS 1080P@24/25/30/48/50/60/120FPS 720P@24/25/30/48/50/60/120/240FPS		
Video Format	H.264		
Video Slow Motion	OFF, 4K2X, 1080P4X, 720P8X		
Photo Format	JPG		
Photo Resolution (with Master Board)	20MP (5200x3900) (Differential) 13MP (4160x3120) (Differential) 12MP (4040x3040) (Differential) 10MP (3648x2736) (Differential) 8MP (3840x2160) 5MP (2592x1944) 3MP (2048x1536) 2MP (1920x1080)		
Operating Temperature	-10°C to +60°C		
Storage Temperature	-20°C to +80°C		
Humidity	20% to 80%		
PCB Dimensions	14.5 x 18.1 mm		
Module Size	14.5 x 18.1 x 19.5 mm		



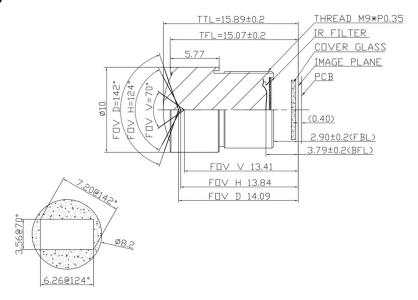
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Lens Specifications

L143_004		
2.95 mm		
15.89 mm		
3.79 mm		
2.9 mm		
Ø8.2		
2.4		
M9 x P0.35		
4G3P + IR		
T=50%@430nm +/- 10nm		
142° (DFOV) (y' = 7.2 mm)		
124° (HFOV) (y' = 6.26 mm)		
70° (VFOV) (y' = 3.558 mm)		
<19°		
<-32%		
>66%		
-20°C to +80°C		
-40°C to +90°C		

Lens Drawing



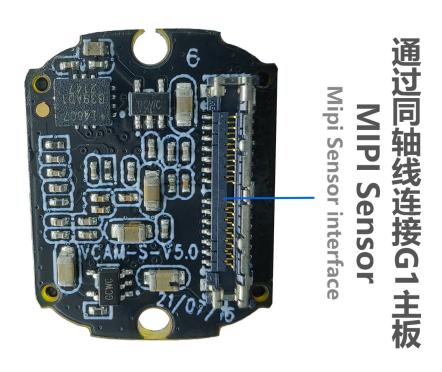


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G1-IMX317 L143模组





SONY

[Product Information]

Ver.1.0

IMX317CQC

Diagonal 7.20 mm (Type 1/2.5) CMOS Image Sensor with Square Pixel for Color Cameras

Description

The IMX317CQC is a diagonal 7.20 mm (Type 1/2.5) CMOS image sensor with a color square pixel array and approximately 8.51 M effective pixels. 12-bit digital output makes it possible to output the signals of approximately 8.51 M effective pixels with high definition for shooting still pictures. It also operates with three power supply voltages: analog 2.8 V, digital 1.2 V, and 1.8 V for I/O interface and achieves low power consumption. Furthermore, it realizes 12-bit digital output for shooting high-speed and high-definition moving pictures by horizontal and vertical addition and subsampling. Realizing high-sensitivity, low dark current, this sensor also has an electronic shutter function with variable storage time.

In addition, this product is designed for use in consumer use digital still camera and consumer use camcorder. When using this for another application, Sony Semiconductor Solutions Corporation does not guarantee the quality and reliability of the product. Therefore, don't use this for applications other than consumer use digital still camera and consumer use camcorder.

In addition, individual specification change cannot be supported because this is a standard product. Consult your Sony Semiconductor Solutions Corporation sales representative if you have any questions.

Features

- ◆ CMOS active pixel type pixels
- ◆ Input clock frequency 6 to 27 MHz (CSI-2), 12/24/36/72 MHz (Sub-LVDS)
- ◆ Both MIPI Specifications (CSI-2 high-speed serial interface) and Sub-LVDS supported
- ◆All-pixel scan mode

Various readout modes (*)

- ♦ High-sensitivity, low dark current, no smear, excellent anti-blooming characteristics
- ◆ Vertical and horizontal arbitrary cropping function
- ◆ Variable-speed shutter function (minimum unit: 1 horizontal period)
- ◆ Low power consumption
- Digital Overlap High Dynamic Range (DOL-HDR) function
- ◆ H driver, V driver and serial communication circuit on chip
- ◆ CDS/PGA on chip: Gain +27 dB (step pitch 0.1 dB)
- ◆10-bit/12-bit A/D conversion on chip
- R, G, B primary color mosaic filters on chip
- ◆ All-pixel simultaneous reset supported
- 92-pin high-precision ceramic package

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^{*} Please refer to the datasheet for binning/subsampling details of readout modes.

Device Structure

◆ CMOS image sensor

♦ Image size Diagonal 7.20 mm (Type 1/2.5)

◆ Total number of pixels
 ♦ Number of effective pixels
 3864 (H) x 2218 (V) approx. 8.57 M pixels
 3864 (H) x 2202 (V) approx. 8.51 M pixels

♦ Number of active pixels 3864 (H) x 2196 (V) approx. 8.49 M pixels diagonal 7.20 mm

◆ Number of recommended recording pixels 3840 (H) x 2160 (V) 8.29 M pixels aspect ratio 16:9
 ◆ Chip size 8.365 mm (H) x 6.615 mm (V) (include scribe area)

♦ Unit cell size 1.62 μm (H) × 1.62 μm (V)

◆ Optical black Horizontal (H) direction: Front 0 pixel, Rear 0 pixel

Vertical (V) direction: Front 16 pixels, Rear 0 pixel

◆ Package 92 pin LGA

Image Sensor Characteristics

(Tj = 60 °C)

Item		Value	Remarks
Sensitivity (F5.6)	Тур.	1145 digit	1/30 s integration
Saturation signal	Min.	3050 digit	

Basic Drive Mode

Drive mode	Number of recording pivels	Max frame rate [frame/s]		Output data
Drive mode	Number of recording pixels	CSI-2	Sub-LVDS	bit length [bit]
Readout mode 0	3840 (H) × 2160 (V) approx. 8.29 M pixels	32.81	32.73	12
Readout mode 1	3840 (H) x 2160 (V) approx. 8.29 M pixels	62.52	62.06	10
Readout mode 2	1920 (H) × 1080 (V) approx. 2.07 M pixels	65.82	65.61	12
Readout mode 3	1920 (H) × 1080 (V) approx. 2.07 M pixels	124.80	124.40	10
Readout mode 4	1920 (H) × 1080 (V) approx. 2.07 M pixels	124.80	124.40	10
Readout mode 5	1280 (H) × 720 (V) approx. 0.92 M pixels	185.73	184.86	10
Readout mode 6	1280 (H) x 540 (V) approx. 0.69 M pixels	249.26	247.70	10



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Cameras Applications







Automotive Driver Pilot

Live Streaming

Video Conference







Eye Tracker Biometric Detection

Machine Vision

Agricultural Monitor







Night Vision Security

Drone and Sports Eagle Eyes

Interactive Pet Camera



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Camera Module Pinout Definition Reference Chart

OmniVision Sony Samsung On-Semi Aptina Himax GalaxyCore PixArt SmartSens Sensors			
Pin Signal	Description		
DGND GND	ground for digital circuit		
AGND	ground for analog circuit		
PCLK DCK	DVP PCLK output		
XCLR PWDN XSHUTDOWN STANDBY	power down active high with internal pull-down resistor		
MCLK XVCLK XCLK INCK	system input clock		
RESET RST	reset active low with internal pull-up resistor		
NC NULL	no connect		
SDA SIO_D SIOD	SCCB data		
SCL SIO_C SIOC	SCCB input clock		
VSYNC XVS FSYNC	DVP VSYNC output		
HREF XHS	DVP HREF output		
DOVDD	power for I/O circuit		
AFVDD	power for VCM circuit		
AVDD	power for analog circuit		
DVDD	power for digital circuit		
STROBE FSTROBE	strobe output		
FSIN	synchronize the VSYNC signal from the other sensor		
SID	SCCB last bit ID input		
ILPWM	mechanical shutter output indicator		
FREX	frame exposure / mechanical shutter		
GPIO	general purpose inputs		
SLASEL	I2C slave address select		
AFEN	CEN chip enable active high on VCM driver IC		
MIPI Interface	3		
MDN0 DN0 MD0N DATA_N DMO1N	MIPI 1st data lane negative output		
MDP0 DP0 MD0P DATA P DMO1P	MIPI 1st data lane positive output		
MDN1 DN1 MD1N DATA2 N DMO2N	MIPI 2nd data lane negative output		
MDP1 DP1 MD1P DATA2 P DMO2P	MIPI 2nd data lane positive output		
MDN2 DN2 MD2N DATA3 N DMO3N	MIPI 3rd data lane negative output		
MDP2 DP2 MD2P DATA3 P DMO3P	MIPI 3rd data lane positive output		
MDN3 DN3 MD3N DATA4 N DMO4N	MIPI 4th data lane negative output		
MDP3 DP3 MD3P DATA4_P DMO4P	MIPI 4th data lane positive output		
MCN CLKN CLK_N DCKN	MIPI clock negative output		
MCP CLKP MCP CLK_P DCKN	MIPI clock positive output		
DVP Parallel Interface			
D0 D00 Y0	DVP data output port 0		
D1 D01 Y1	DVP data output port 1		
D2 DO2 Y2	DVP data output port 2		
D3 DO3 Y3	DVP data output port 3		
D4 DO4 Y4	DVP data output port 4		
D5 DO5 Y5	DVP data output port 5		
D6 D06 Y6	DVP data output port 6		
D7 D07 Y7	DVP data output port 7		
D8 DO8 Y8	DVP data output port 8		
D9 DO9 Y9	DVP data output port 9		
D10 DO10 Y10	DVP data output port 10		
D11 D011 Y11	DVP data output port 11		
ווו ווטס ווס	DVI data output port 11		



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Camera Reliability Test

Reliability Inspection Item			Tanking Makhad	A Criteria	
Category		Item	Testing Method	Acceptance Criteria	
	Storage	High 60°C 96 Hours	Temperature Chamber	No Abnormal Situation	
	Temperature	Low -20°C 96 Hours	Temperature Chamber	No Abnormal Situation	
	Operation Temperature	High 60°C 24 Hours	Temperature Chamber	No Abnormal Situation	
Environmental		Low -20°C 24 Hours	Temperature Chamber	No Abnormal Situation	
Environmental	Humidity	60°C 80% 24 Hours Temperature Chamber		No Abnormal Situation	
	Thermal Shock High 60°C 0.5 Hours Low -20°C 0.5 Hours Cycling in 24 Hours		Temperature Chamber	No Abnormal Situation	
	Drop Test	Without Package 60cm	10 Times on Wood Floor	Electrically Functional	
	(Free Falling)	With Package 60cm	10 Times on Wood Floor	Electrically Functional	
	Vibration Test	50Hz X-Axis 2mm 30min	Vibration Table	Electrically Functional	
Physical		50Hz Y-Axis 2mm 30min	Vibration Table	Electrically Functional	
Titysical		50Hz Z-Axis 2mm 30min	Vibration Table	Electrically Functional	
	Cable Tensile Strength Test Loading Weight 4 kg 60 Seconds Cycling in 24 Hours		Tensile Testing Machine	Electrically Functional	
Electrical	ESD Test	Contact Discharge 2 KV	ESD Testing Machine	Electrically Functional	
		Air Discharge 4 KV	ESD Testing Machine	Electrically Functional	
	Aging Test	On/Off 30 Seconds Cycling in 24 Hours	Power Switch	Electrically Functional	
	USB Connector	On/Off 250 Times	Plug and Unplug	Electrically Functional	











Camera Inspection Standard

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Inspection Item		ı Item	Lancas Cara Marthaud	Standard of Inspection	
Category		Item	Inspection Method		
		Color	The Naked Eye	Major Difference is Not Allowed.	
	FPC/ PCB	Be Torn/Chopped	The Naked Eye	Copper Crack Exposure is Not Allowed.	
		Marking	The Naked Eye	Clear, Recognizable (Within 30cm Distance)	
		Scratches	The Naked Eye	The Inside Crack Exposure is Not Allowed	
	Holder	Gap	The Naked Eye	Meet the Height Standard	
Appearance	Holdel	Screw	The Naked Eye	Make Sure Screws Are Presented (If Any)	
		Damage	The Naked Eye	The Inside Crack Exposure is Not Allowed	
		Scratch	The Naked Eye	No Effect On Resolution Standard	
	Lens	Contamination	The Naked Eye	No Effect On Resolution Standard	
	Lens	Oil Film	The Naked Eye	No Effect On Resolution Standard	
		Cover Tape	The Naked Eye	No Issue On Appearance.	
		No Communication	Test Board	Not Allowed	
	Image	Bright Pixel	Black Board	Not Allowed In the Image Center	
		Dark Pixel	White board	Not Allowed In the Image Center	
		Blurry	The Naked Eye	Not Allowed	
		No Image	The Naked Eye	Not Allowed	
		Vertical Line	The Naked Eye	Not Allowed	
		Horizontal Line	The Naked Eye	Not Allowed	
Function		Light Leakage	The Naked Eye	Not Allowed	
		Blinking Image	The Naked Eye	Not Allowed	
		Bruise	Inspection Jig	Not Allowed	
		Resolution	Chart	Follows Outgoing Inspection Chart Standard	
		Color	The Naked Eye	No Issue	
		Noise	The Naked Eye	Not Allowed	
		Corner Dark	The Naked Eye	Less Than 100px By 100px	
		Color Resolution	The Naked Eye	No Issue	
		Height	The Naked Eye	Follows Approval Data Sheet	
Dimer	neion	Width	The Naked Eye	Follows Approval Data Sheet	
Dilliel	131011	Length	The Naked Eye	Follows Approval Data Sheet	
		Overall	The Naked Eye	Follows Approval Data Sheet	



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YDSCAM Package Solutions

YDS Camera Module



Tray with Grid and Space



Complete with Lens Protection Film



Place Cameras on the Tray





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YDSCAM Package Solutions

Full Tray of Cameras



Place Tray into Anti-Static Bag



Cover Tray with Lid



Vacuum the Anti-Static Bag





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YDSCAM Package Solutions

Sealed Vacuum Anti-Static Bag with Labels

1. Model and Description 2. Quantity 3. Manufacturing Date Code 4. Caution





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YDSCAM Package Solutions

Place Foam Sheets Between Tray Bags



Place Foam Sheets and Trays into Box



Seal the Carbon Box



Foam Sheets are Larger Than Trays



Foam Sheets are Tightly Fitting in Box



Label the Carbon Shipping Box





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YDSCAM Package Solutions

USB Camera Module

Complete with Lens Protection Film







Place Camera Sample into Anti-Static Bag

Place USB Cameras into Tray







Seal the Tray with Anti-Static Bag

Label the Carbon Shipping Box







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YDSCAM Package Solutions

Place Camera Sample into Anti-Static Bag





Label the Sample Bags



Place Samples into the Carbon Box



Place Connectors into Anti-Static Bag





Place Connectors into Reel



Place Connectors into the Carbon Box





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Company YDSCAM

YingDeShun Co. Ltd. (YDS) was established in 2017, a next-generation technology driven manufacturer specialized in research, design, and produce of audio and video products. YDS is occupying 20,000 square feet automated plants with 100 employees of annual throughput 30,000,000 units cameras.

YDS provides OEM, ODM design, contract manufacturing, and builds the camera products. You may provide the requirements to us, even with a hand draft, our sales and engineering work together to meet your needs. We consider ourselves your last-term partner in developing practical and innovative solutions.

Our team covers everything from initial concept development to mass produced product. YDS specializes in customized camera design, raw material, electronic engineering, firmware/software development, product testing, and packing design. Our experienced strategic supply systems offer a robust and dependable manufacturing capacity for orders of various sizes.





Limited Warranty

YDS provides the following limited warranty if you purchased the Product(s) directly from YDS company or from YDS's website www.YDSCAM.com. Product(s) purchased from other sellers or sources are not covered by this Limited Warranty. YDS guarantees that the Product(s) will be free from defects in materials and workmanship under normal use for a period of one (1) year from the date you receive the product ("Warranty Period").

For all Product(s) that contain or develop material defects in materials or workmanship during the Warranty Period, YDS will, at its sole option, either: (i) repair the Product(s); (ii) replace the Product(s) with a new or refurbished Product(s) (replacement Product(s) being of identical model or functional equivalent); or (iii) provide you a refund of the price you paid for the Product(s).

This Limited Warranty of YDS is solely limited to repair and/or replacement on the terms set forth above. YDS is not reliable or responsible for any subsequential events.















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YDS Strength

Powerful Factory





Professional Service







Promised Delivery











